# V8PM12-M3, V8PM12HM3

Vishay General Semiconductor

## High Current Density Surface Mount Trench MOS Barrier Schottky Rectifier

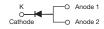
Ultra Low  $V_F = 0.53$  V at  $I_F = 4$  A

## TMBS<sup>®</sup> eSMP<sup>®</sup> Series

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### TO-277A (SMPC)



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	8.0 A			
V <sub>RRM</sub>	120 V			
I <sub>FSM</sub>	140 A			
V <sub>F</sub> at I <sub>F</sub> = 8.0 A	0.63 V			
T <sub>J</sub> max.	150 °C			
Package	TO-277A (SMPC)			
Diode variation	Single die			

### **TYPICAL APPLICATIONS**

For use in low voltage high frequency DC/DC converters, freewheeling, and polarity protection applications.

### FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **MECHANICAL DATA**

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

Base P/NHM3\_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,....)

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

<b>MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V8PM12	UNIT	
Device marking code		8M12		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	120	V	
Maximum DC forward current	I <sub>F</sub> <sup>(1)</sup>	8.0	— A	
	I <sub>F</sub> <sup>(2)</sup>	3.6		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	140	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

### Notes

<sup>(1)</sup> Mounted on 30 mm x 30 mm pad areas aluminum PCB

<sup>(2)</sup> Free air, mounted on recommended copper pad area

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COMPLIANT

HALOGEN



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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 4 A$	T <sub>A</sub> = 25 °C	V <sub>F</sub> (1)	0.62	-	V
	I <sub>F</sub> = 8 A			0.76	0.84	
	$I_F = 4 A$	- T <sub>A</sub> = 125 °C		0.53	-	
	I <sub>F</sub> = 8 A			0.63	0.71	
Reverse current	V <sub>R</sub> = 90 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> (2)	1.7	-	μA
	v <sub>R</sub> = 90 v	T <sub>A</sub> = 125 °C		1.5	-	mA
	V <sub>R</sub> = 120 V	T <sub>A</sub> = 25 °C		-	300	μA
		T <sub>A</sub> = 125 °C		3.1	17	mA

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V8PM12	UNIT	
Typical thermal resistance	R <sub>0JA</sub> <sup>(1)</sup>	62	°C/W	
l ypical thermal resistance	R <sub>0JM</sub> <sup>(2)</sup>	4		

#### Notes

 $^{(1)}$  Free air mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

<sup>(2)</sup> Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8PM12-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
V8PM12-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	
V8PM12HM3/86A (1)	0.10	86A	1500	7" diameter plastic tape and reel	
V8PM12HM3/87A <sup>(1)</sup>	0.10	87A	6500	13" diameter plastic tape and reel	
V8PM12HM3_A/H <sup>(1)</sup>	0.10	Н	1500	7" diameter plastic tape and reel	
V8PM12HM3_A/I <sup>(1)</sup>	0.10		6500	13" diameter plastic tape and reel	

#### Note

(1) AEC-Q101 qualified



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## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

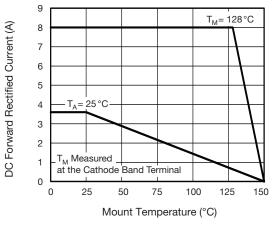


Fig. 1 - Forward Current Derating Curve

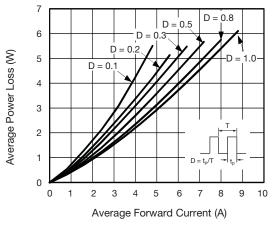
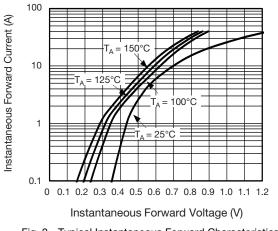


Fig. 2 - Forward Power Loss Characteristics





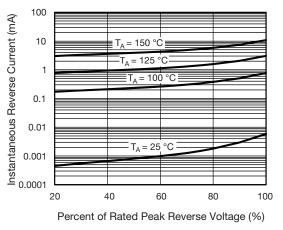


Fig. 4 - Typical Reverse Leakage Characteristics

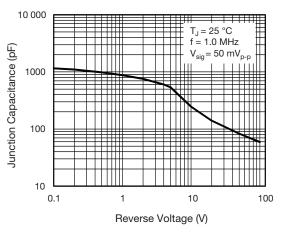


Fig. 5 - Typical Junction Capacitance

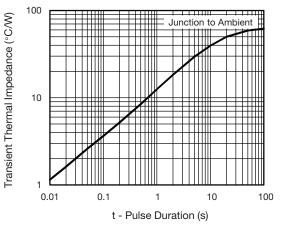


Fig. 6 - Typical Transient Thermal Impedance

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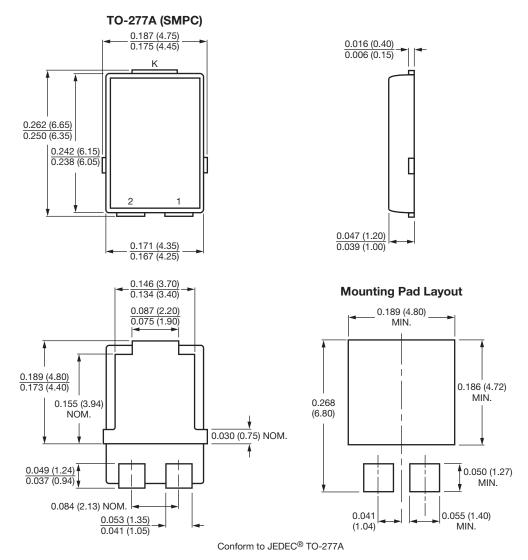
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## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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